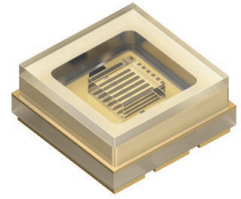


SU CULDN1.VC

OSLON® UV 3636

This compact UV-C LED is part of the OSLON UV series.

It allows a flexible design for any application which requires UV-C radiation for e.g. disinfection, purification, treatment or sensing.



Applications

- Equipment Illumination (e.g. Curing, Endoscope)
- Smoke/Dust/Particle Sensing
- UV-C Air Disinfection
- UV-C Surface Disinfection
- UV-C Water Disinfection

Features:

- Package: Ceramic package with integrated glass cover
- Chip technology: AlGaIn based Flip chip
- Typ. Radiation: 120° (Lambertian emitter)
- Color: $\lambda_{\text{peak}} = 275 \text{ nm}$ (• ultraviolet (UV-C))
- ESD: 5 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM)
- Radiant Flux: typ. 42 mW
- Radiant Efficiency: typ. 2.1 %

Ordering Information

Type	Radiant Intensity ¹⁾ $I_F = 350 \text{ mA}$ I_e	Ordering Code
SU CULDN1.VC-MAMP-67-4E4F	30.0 ... 100.0 mW	Q65113A2365

Maximum Ratings

Parameter	Symbol		Values
Operating Temperature	T_{op}	min.	-40 °C
		max.	60 °C
Storage Temperature	T_{stg}	min.	-40 °C
		max.	100 °C
Junction Temperature	T_j	max.	85 °C
Forward current $T_s = 25\text{ °C}$	I_F	min.	1 mA
		max.	500 mA
Surge Current $T_s = 25\text{ °C}$	I_{FS}	max.	750 mA
Reverse voltage ²⁾ $T_s = 25\text{ °C}$	V_R	max.	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM)	V_{ESD}		5 kV

Characteristics

$I_F = 350 \text{ mA}$; $T_s = 25 \text{ °C}$

Parameter	Symbol		Values
Peak Wavelength ³⁾	λ_{peak}	min. typ. max.	270 nm 275 nm 280 nm
Viewing angle at 50% I_v	2ϕ	typ.	120 °
Forward Voltage ⁴⁾ $I_F = 350 \text{ mA}$	V_F	min. typ. max.	5.00 V 5.70 V 6.00 V
Real thermal resistance junction/solderpoint ⁵⁾	$R_{\text{thJS real}}$	typ.	6.3 K / W
Electrical thermal resistance junction/solderpoint with efficiency $\eta_e = 2.1 \text{ %}$	$R_{\text{thJS elec.}}$	typ.	6.2 K / W

Brightness Groups

Group	Radiant Intensity ¹⁾ $I_F = 350 \text{ mA}$ min. I_e	Radiant Intensity ¹⁾ $I_F = 350 \text{ mA}$ max. I_e
MA	30.0 mW	35.0 mW
MB	35.0 mW	40.0 mW
MC	40.0 mW	45.0 mW
MD	45.0 mW	50.0 mW
ME	50.0 mW	55.0 mW
MF	55.0 mW	60.0 mW
MG	60.0 mW	65.0 mW
MH	65.0 mW	70.0 mW
MJ	70.0 mW	75.0 mW
MK	75.0 mW	80.0 mW
ML	80.0 mW	85.0 mW
MM	85.0 mW	90.0 mW
MN	90.0 mW	95.0 mW
MP	95.0 mW	100.0 mW

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ $I_F = 350 \text{ mA}$ min. V_F	Forward Voltage ⁴⁾ $I_F = 350 \text{ mA}$ max. V_F
4E	5.00 V	5.50 V
4F	5.50 V	6.00 V

Wavelength Groups

Group	Peak Wavelength ³⁾ min. λ_{peak}	Peak Wavelength ³⁾ max. λ_{peak}
6	270 nm	275 nm
7	275 nm	280 nm

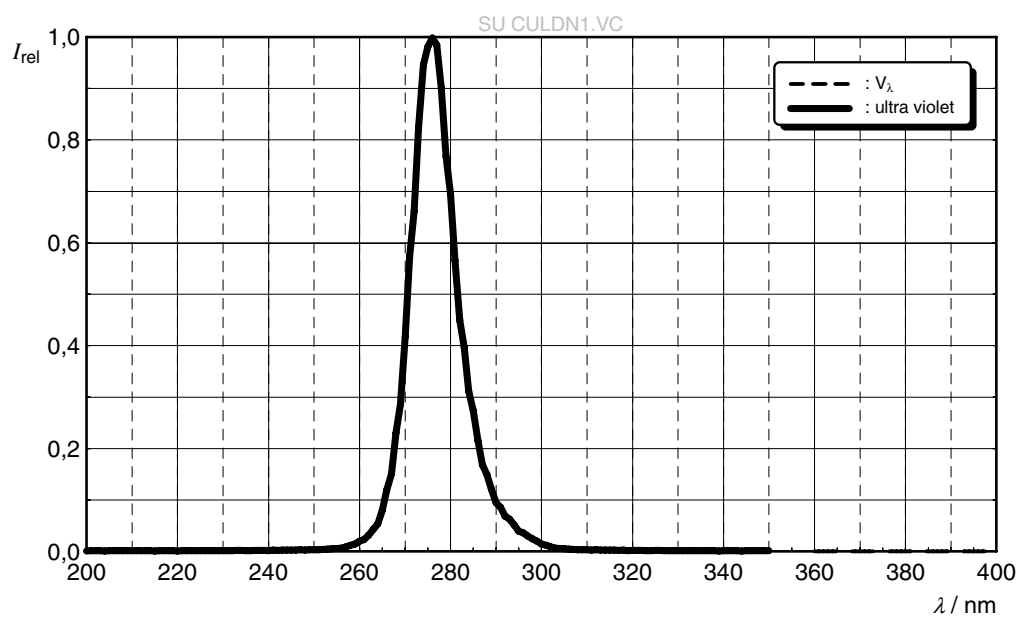
Group Name on Label

Example: MA-6-4E

Brightness	Wavelength	Forward Voltage
MA	6	4E

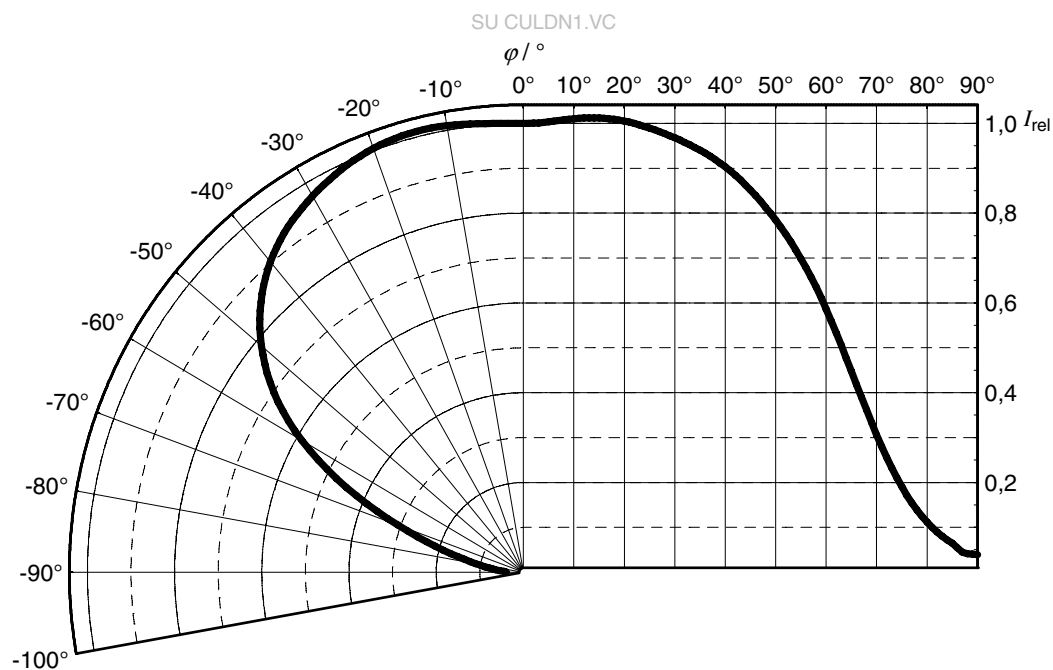
Relative Spectral Emission ⁶⁾

$I_{\text{rel}} = f(\lambda)$; $I_F = 350 \text{ mA}$; $T_S = 25 \text{ }^\circ\text{C}$



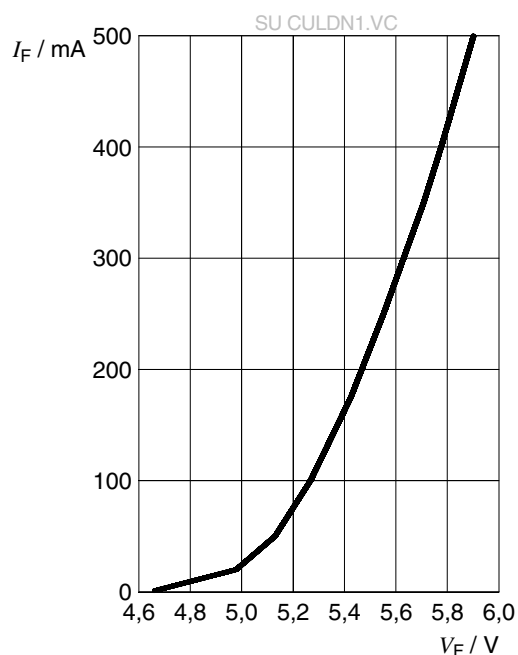
Radiation Characteristics ⁶⁾

$I_{\text{rel}} = f(\phi)$; $T_S = 25 \text{ }^\circ\text{C}$

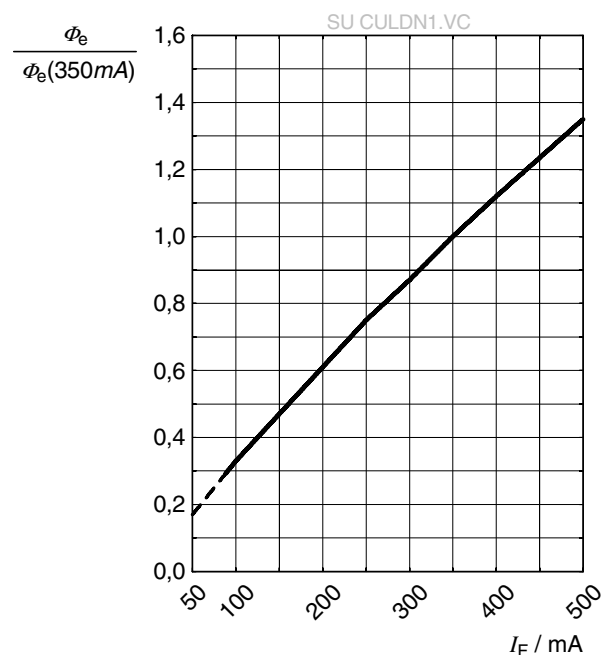


Forward current ⁶⁾

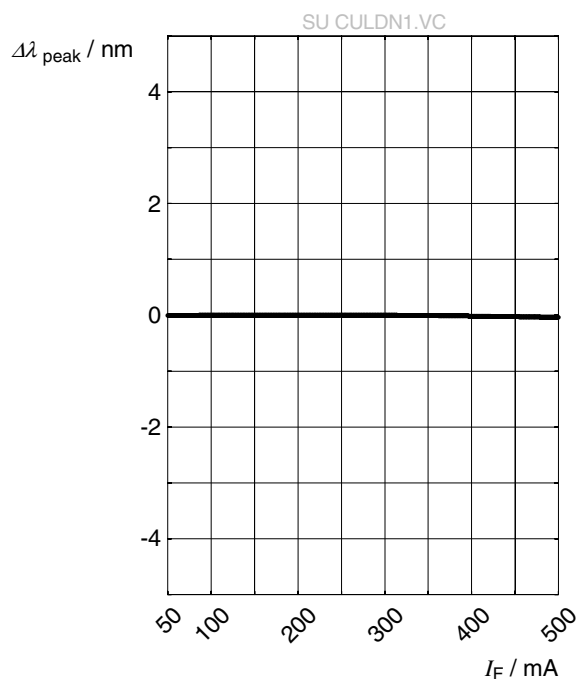
$$I_F = f(V_F); T_S = 25\text{ °C}$$

**Relative Radiant Power** ^{6), 7)}

$$\Phi_E / \Phi_E(350\text{ mA}) = f(I_F); T_S = 25\text{ °C}$$

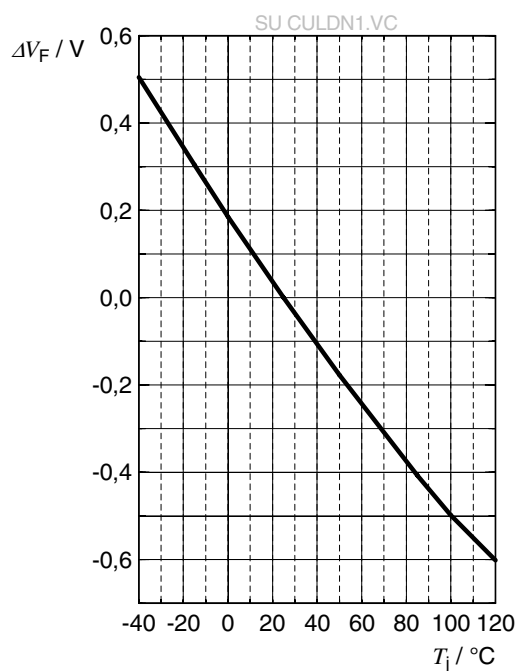
**Peak Wavelength** ⁶⁾

$$\lambda_{\text{peak}} = f(T_j); I_F = 350\text{ mA}$$

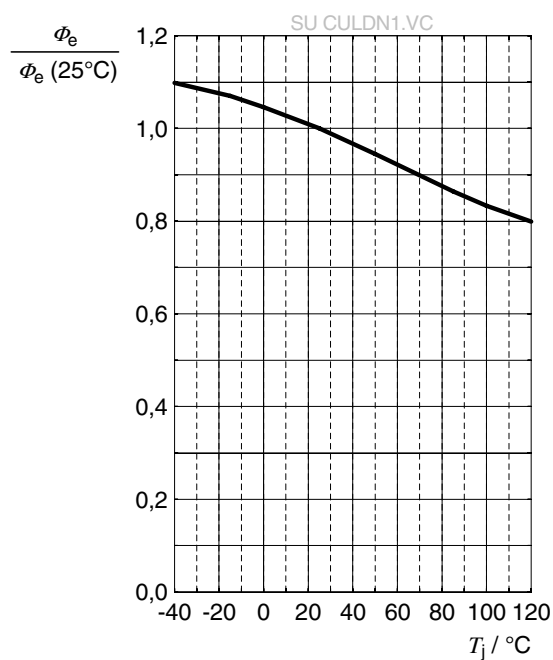


Forward Voltage ⁶⁾

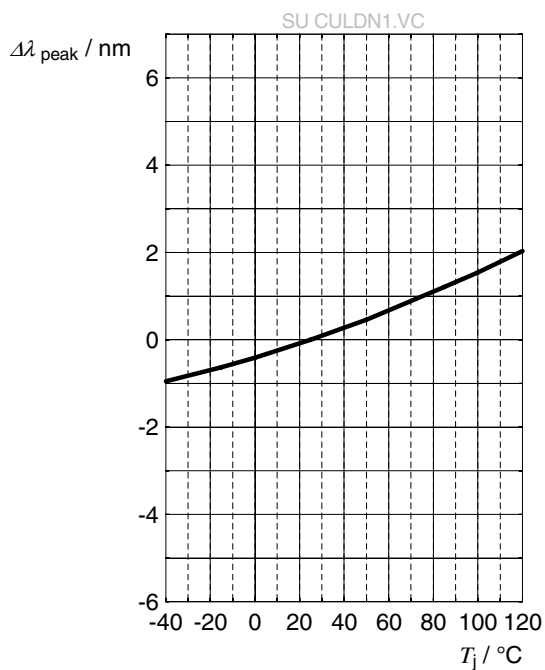
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$

**Relative Radiant Power** ⁶⁾

$$\Phi_E / \Phi_E(25^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$

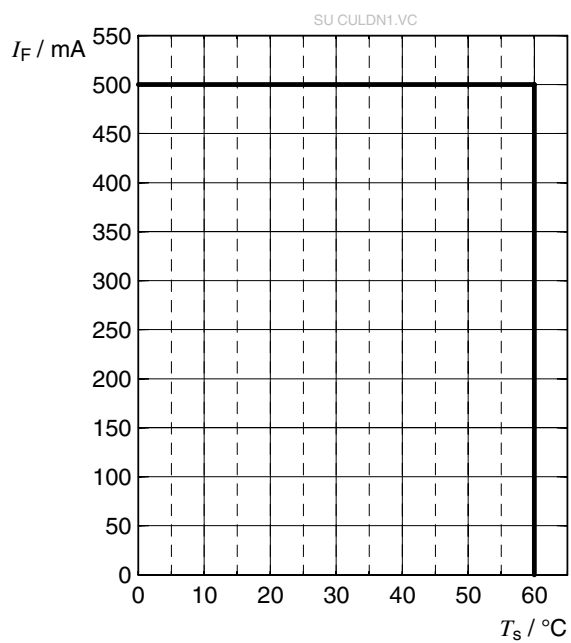
**Peak Wavelength** ⁶⁾

$$\lambda_{\text{peak}} = f(T_j); I_F = 350\text{ mA}$$

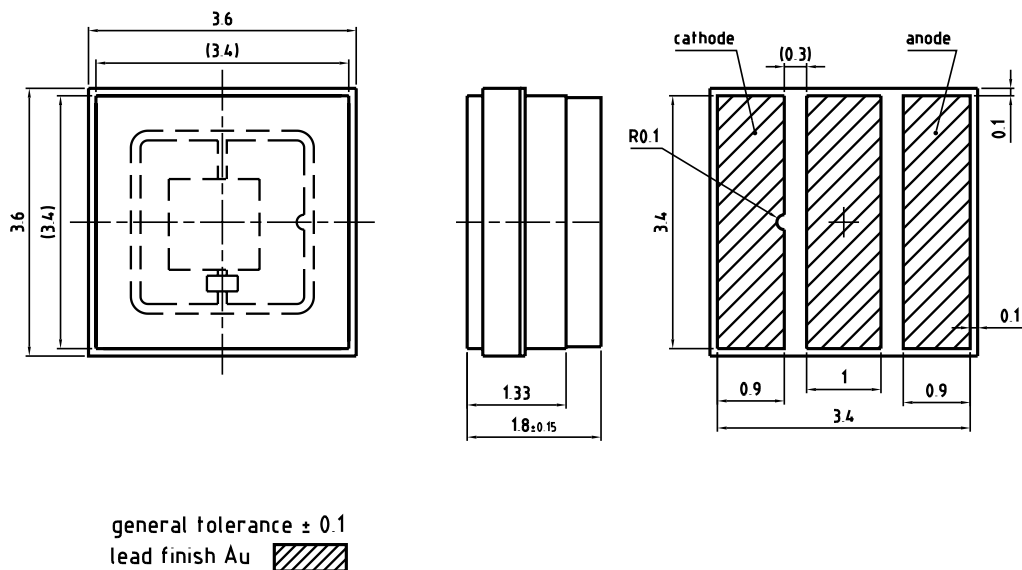


Max. Permissible Forward Current

$$I_F = f(T)$$



Dimensional Drawing ⁸⁾



C67062-A0383-A1-02

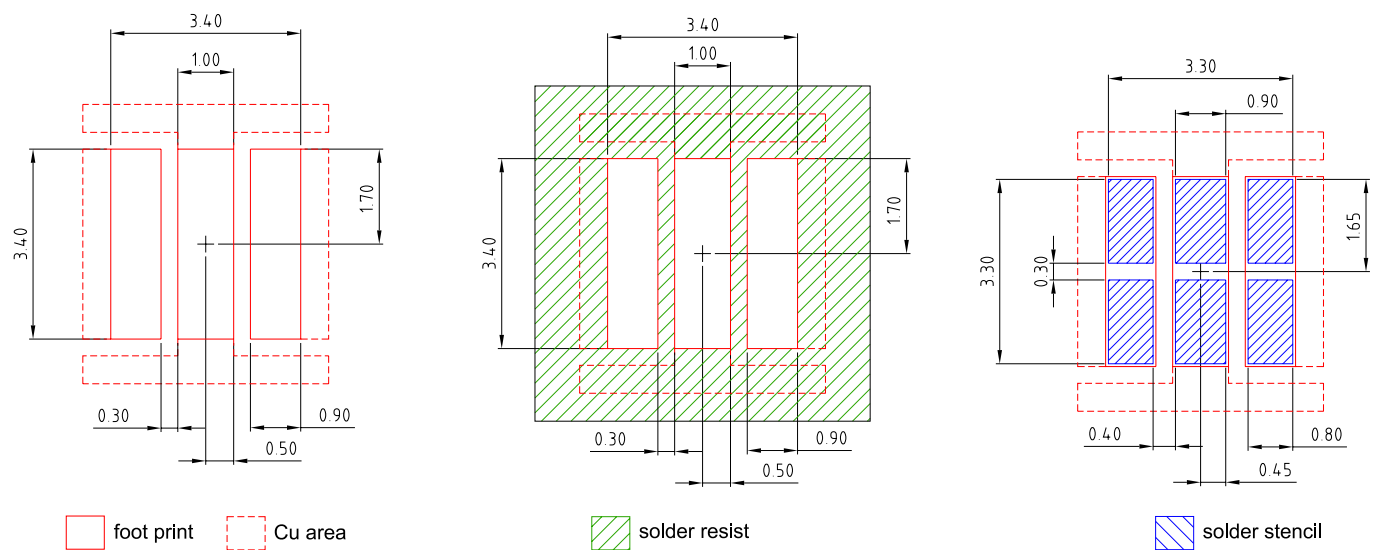
Further Information:

Approximate Weight: 82.6 mg

Package marking: Cathode

ESD advice: LED is protected by ESD device which is connected in parallel to LED-Chip.

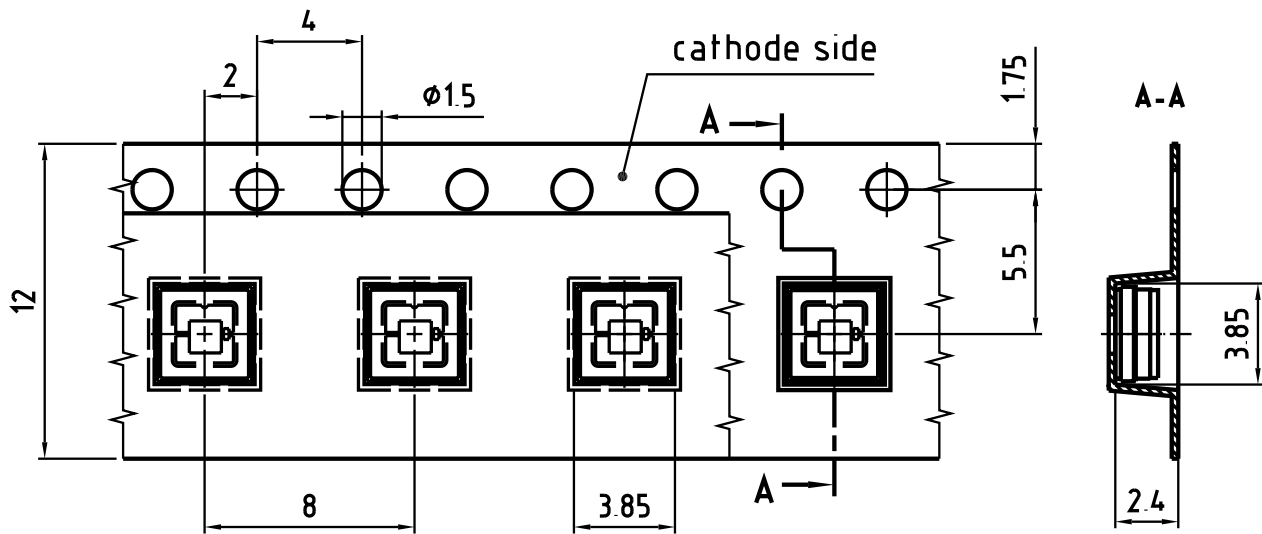
Recommended Solder Pad ⁸⁾



E067.0346.19-01

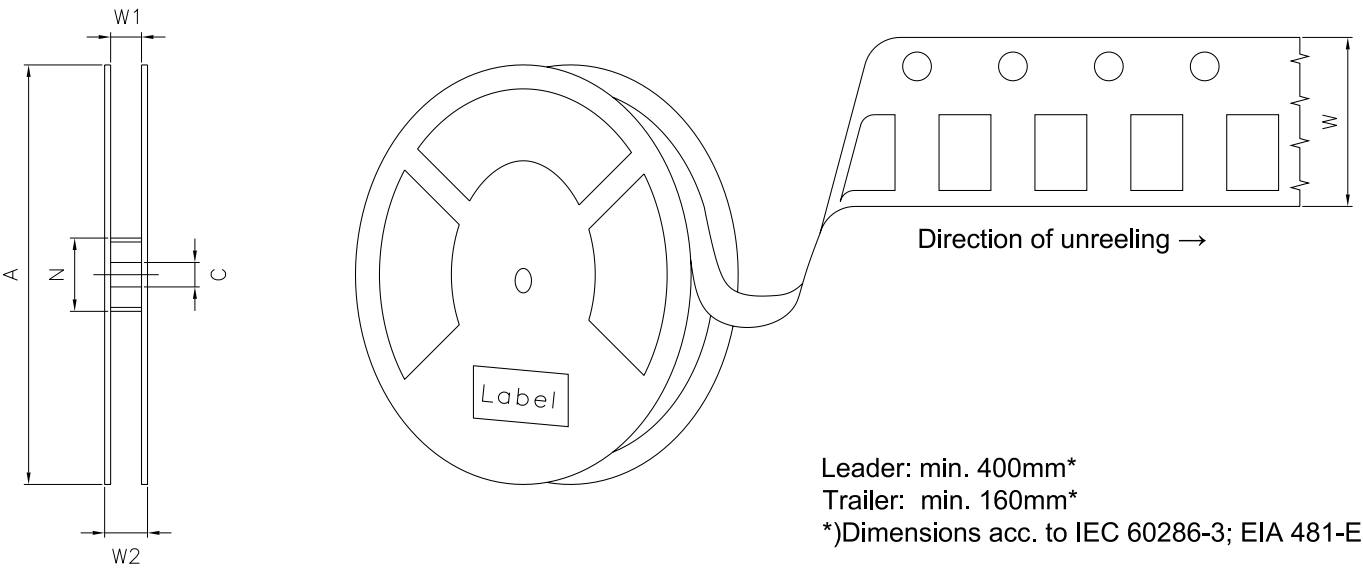
For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for any kind of wet cleaning or ultrasonic cleaning.

Taping ⁸⁾



C67062-A0383-B2-01

Tape and Reel ⁹⁾



Reel Dimensions

A	W	N _{min}	W ₁	W _{2 max}	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	100

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors

LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

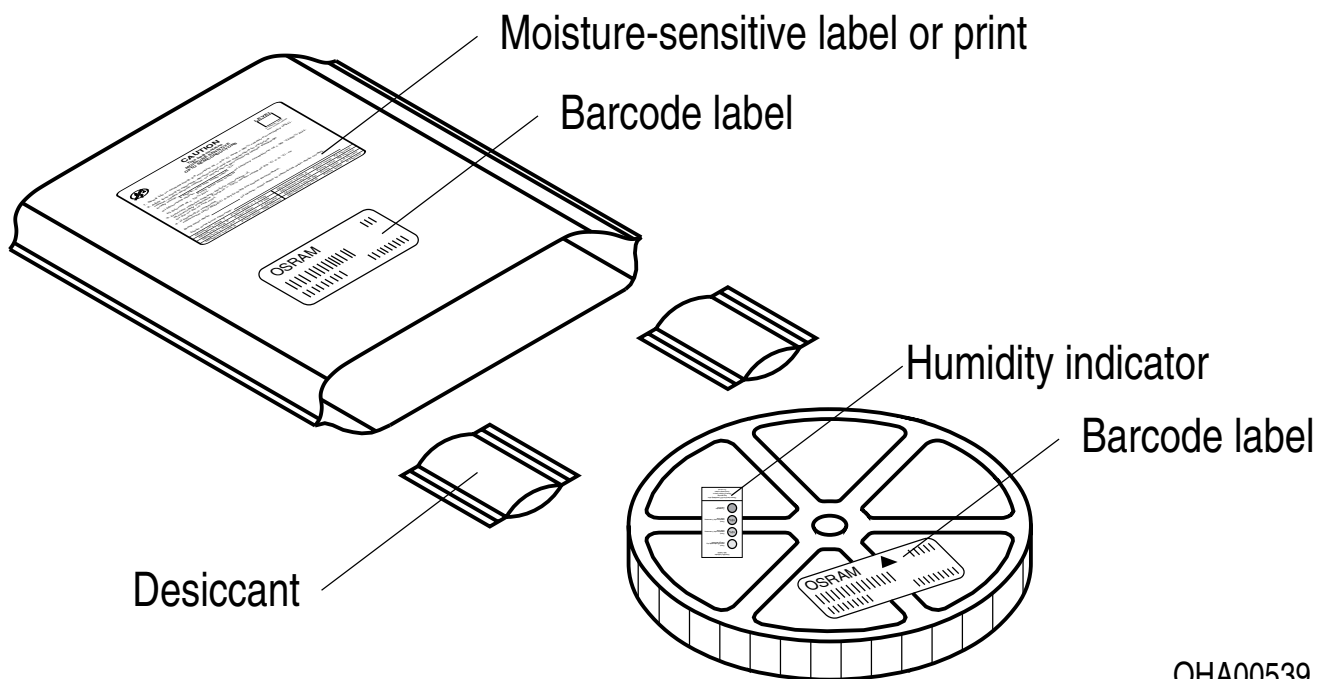
(1T) LOT NO: 1234567890 (9D) D/C: 1234

ML Temp ST
X XXX °C X

Pack: RXX
DEMY XXX
X_X123_1234.1234 X

(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

OHA04563

Dry Packing Process and Materials ⁸⁾

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into high risk group – RG3. WARNING - UV emitted from this product. Avoid eye and skin contact to unshielded product.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Brightness:** Brightness groups are tested at a current pulse duration of 25 ms and a tolerance of $\pm 11\%$.
- 2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- 3) **Wavelength:** Wavelengths are tested at a current pulse duration of 25 ms and a tolerance of ± 1 nm.
- 4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ± 0.1 V.
- 5) **Thermal Resistance:** $R_{th\ max}$ is based on statistic values (6σ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.0	2020-11-27	Initial Version

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